

Patent Abstracts of Japan

PUBLICATION NUMBER : 11008485
PUBLICATION DATE : 12-01-99

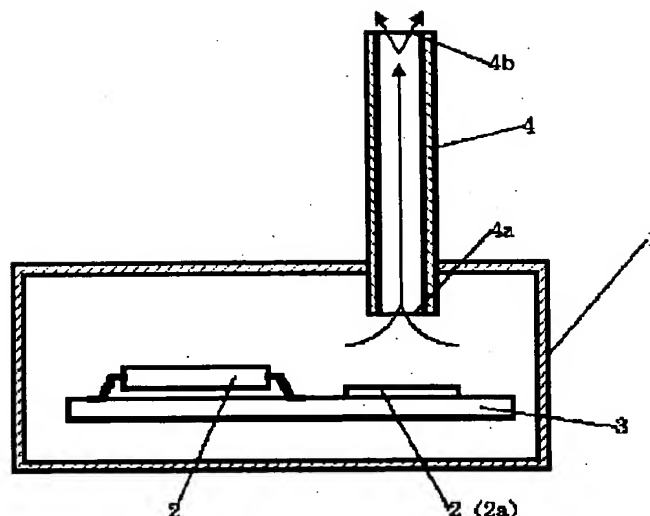
APPLICATION DATE : 16-06-97
APPLICATION NUMBER : 09158250

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INT.CL. : H05K 7/20 H01L 23/467

TITLE : COOLING STRUCTURE OF
ELECTRONIC EQUIPMENT



ABSTRACT : **PROBLEM TO BE SOLVED:** To provide a cooling structure of electronic equipment which is inexpensive and simple and is capable of efficiently cooling portable electronic equipment with a small space, such as a notebook-type personal computer.

SOLUTION: The cooling structure of an electronic equipment contains a body 1 housing electronic components 2 therein, and a chimney-like cylinder 4 which is formed in such a manner that the cylinder 4 is protruded from the body 1 and has a suction port 4a at one end of the cylinder 4 and a discharge port 4b at the other end. The suction port 4a of the cylinder 4 is positioned above a CPU chip 2a, an electronic component which produces high heat, placed inside the body 1.

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